TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (π-MOSV)

# 2SK3130

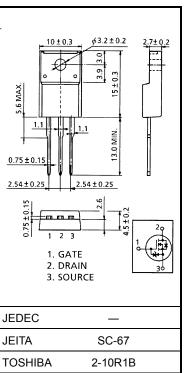
### **Switching Regulator Applications**

Unit: mm

- Reverse-recovery time:  $t_{rr} = 85 \text{ ns}$
- Built-in high-speed flywheel diode
- Low drain-source ON resistance: RDS (ON) =  $1.12 \Omega$  (typ.)
- High forward transfer admittance:  $|Y_{fs}| = 5.0 \text{ S (typ.)}$
- Low leakage current: IDSS = 100 μA (max) (VDS = 600 V)
- Enhancement model:  $V_{th} = 2.0 \sim 4.0 \text{ V (V}_{DS} = 10 \text{ V, I}_{D} = 1 \text{ mA})$

### Maximum Ratings (Ta = 25°C)

Characteristics			Symbol	Rating	Unit	
Drain-source voltage			$V_{DSS}$	600	V	
Drain-gate voltage ( $R_{GS} = 20 \text{ k}\Omega$ )			$V_{DGR}$	600	V	
Gate-source voltage			V <sub>GSS</sub>	±30	V	
Drain current	DC	(Note 1)	I <sub>D</sub>	6	Α	
	Pulse	(Note 1)	I <sub>DP</sub>	24	"	
Drain power dissipation (Tc = 25°C)			$P_{D}$	40	W	
Single pulse avalanche energy (Note 2)			E <sub>AS</sub>	345	mJ	
Avalanche current			I <sub>AR</sub>	6	Α	
Repetitive avalanche energy (Note 3)			E <sub>AR</sub>	4	mJ	
Channel temperature			T <sub>ch</sub>	150	°C	
Storage temperature range			T <sub>stg</sub>	-55~150	°C	



Weight: 1.9 g (typ.)

#### **Thermal Characteristics**

Characteristics	Symbol	Max	Unit	
Thermal resistance, channel to case	R <sub>th (ch-c)</sub>	3.125	°C/W	
Thermal resistance, channel to ambient	R <sub>th (ch-a)</sub>	62.5	°C/W	

Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2:  $V_{DD} = 90~V,~T_{ch} = 25^{\circ}C$  (initial),  $L = 16.8~mH,~R_G = 25~\Omega,~I_{AR} = 6~A$ 

Note 3: Repetitive rating: pulse width limited by maximum channel temperature.

This transistor is an electrostatic-sensitive device. Please handle with caution



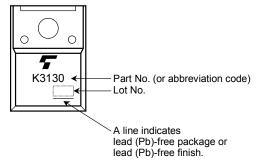
## Electrical Characteristics (Ta = 25°C)

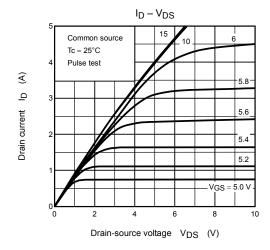
Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage current		I <sub>GSS</sub>	$V_{GS} = \pm 25 \text{ V}, V_{DS} = 0 \text{ V}$	_	_	±10	μА
Gate-source brea	akdown voltage	V (BR) GSS	$I_G = \pm 100 \ \mu A, \ V_{DS} = 0 \ V$	±30	_	_	V
Drain cut-OFF cu	ırrent	I <sub>DSS</sub>	V <sub>DS</sub> = 600 V, V <sub>GS</sub> = 0 V	_	_	100	μА
Drain-source bre	akdown voltage	V (BR) DSS	$I_D = 10$ mA, $V_{GS} = 0$ V	600	_	_	V
Gate threshold voltage		V <sub>th</sub>	$V_{DS} = 10 \text{ V}, I_{D} = 1 \text{ mA}$	2.0	_	4.0	V
Drain-source ON resistance		R <sub>DS</sub> (ON)	$V_{GS} = 10 \text{ V}, I_D = 3 \text{ A}$	_	1.12	1.55	Ω
Forward transfer admittance		Y <sub>fs</sub>	$V_{DS} = 10 \text{ V}, I_D = 3 \text{ A}$	1.5	5.0	_	S
Input capacitance		C <sub>iss</sub>	V <sub>DS</sub> = 10 V, V <sub>GS</sub> = 0 V, f = 1 MHz	_	1300	_	pF
Reverse transfer capacitance		C <sub>rss</sub>		_	130	_	
Output capacitance		C <sub>oss</sub>		_	400	_	
Switching time	Rise time	t <sub>r</sub>	10 V ID = 3 A VOUT		25		- ns
	Turn-ON time	t <sub>on</sub>	VGS 0 V = 100 O		45		
	Fall time	t <sub>f</sub>	$0 \text{ V} \longrightarrow \mathbb{R}_{L} = 100 \Omega$ $R_{L} = 100 \Omega$ $R_{D} \simeq 300 \text{ V}$		40		
	Turn-OFF time	t <sub>off</sub>	Duty $\leq$ 1%, $t_W = 10 \mu s$	_	150		
Total gate charge (gate-source plus gate-drain)		Qg		_	30		nC
Gate-source charge		Q <sub>gs</sub>	$V_{DD} \simeq 400 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 6 \text{ A}$	_	18	_	
Gate-drain ("miller") charge		Q <sub>gd</sub>		_	12	_	

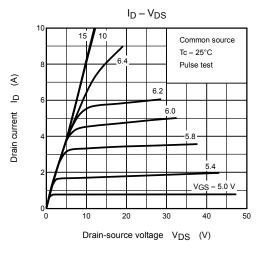
## Source-Drain Ratings and Characteristics (Ta = 25°C)

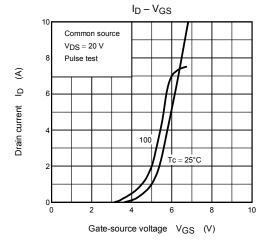
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	$I_{DR}$	_	_	_	6	Α
Pulse drain reverse current (Note 1)	I <sub>DRP</sub>	_	-	_	24	Α
Forward voltage (diode)	V <sub>DSF</sub>	$I_{DR} = 6 \text{ A}, V_{GS} = 0 \text{ V}$	_	_	-1.7	V
Reverse recovery time	t <sub>rr</sub>	$I_{DR} = 6 \text{ A}, V_{GS} = 0 \text{ V},$	_	85	_	ns
Reverse recovery charge	Q <sub>rr</sub>	$dI_{DR}/dt = 100 \text{ A/}\mu\text{s}$		0.21	_	μС

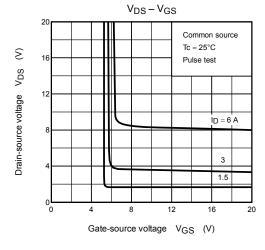
## Marking

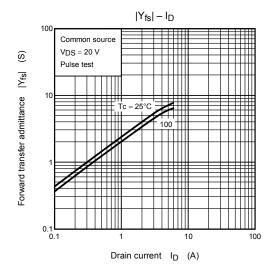


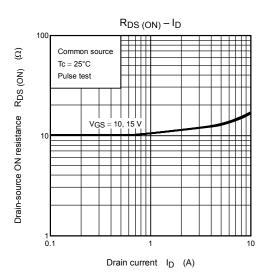


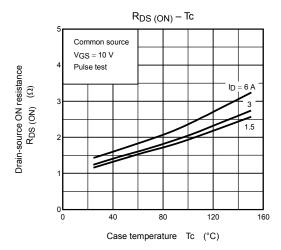


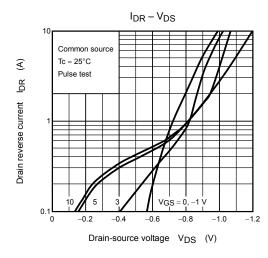


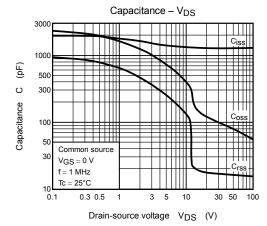


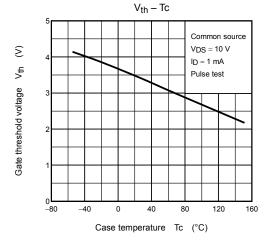


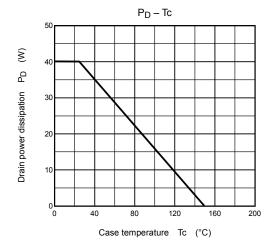


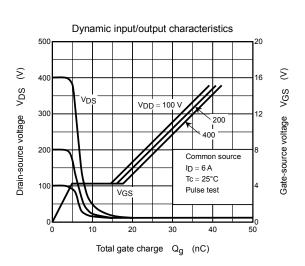


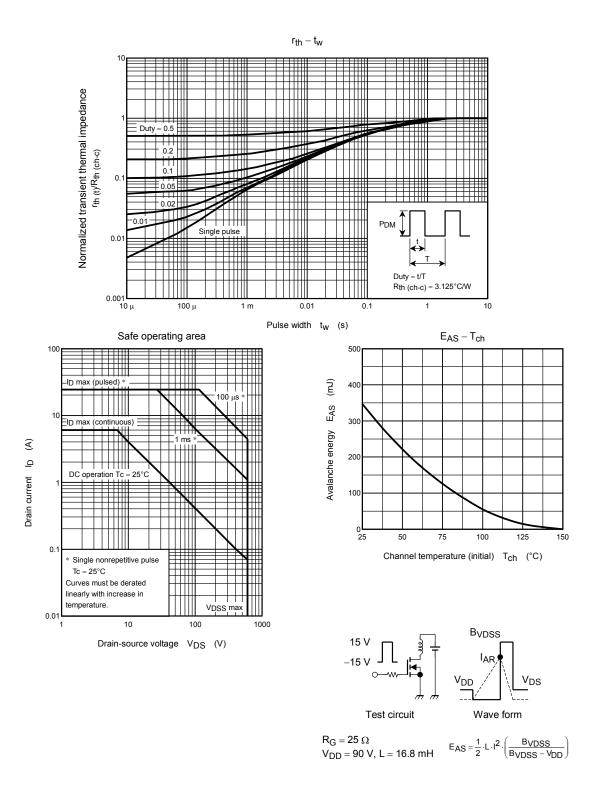












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